

## 3A, 50V - 600V Super Fast Surface Mount Rectifier

### FEATURES

- Glass passivated chip junction
- Ideal for automated placement
- Super fast recovery time for high efficiency
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

### APPLICATIONS

- High frequency rectification
- Freewheeling application
- Switching mode converters and inverters in computer, and telecommunication.

### MECHANICAL DATA

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.210g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
$I_F$	3	A
$V_{RRM}$	50 - 600	V
$I_{FSM}$	100	A
$T_{JMAX}$	150	°C
Package	DO-214AB (SMC)	
Configuration	Single die	



**DO-214AB (SMC)**



ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)										
PARAMETER	SYMBOL	ES3A	ES3B	ES3C	ES3D	ES3F	ES3G	ES3H	ES3J	UNIT
Marking code on the device		ES3A	ES3B	ES3C	ES3D	ES3F	ES3G	ES3H	ES3J	
Repetitive peak reverse voltage	$V_{RRM}$	50	100	150	200	300	400	500	600	V
Reverse voltage, total rms value	$V_{R(RMS)}$	35	70	105	140	210	280	350	420	V
Forward current	$I_F$	3								A
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	$I_{FSM}$	100								A
Junction temperature	$T_J$	- 55 to +150								°C
Storage temperature	$T_{STG}$	- 55 to +150								°C

<b>THERMAL PERFORMANCE</b>			
<b>PARAMETER</b>	<b>SYMBOL</b>	<b>TYP</b>	<b>UNIT</b>
Junction-to-lead thermal resistance	$R_{\theta JL}$	12	$^{\circ}\text{C/W}$
Junction-to-ambient thermal resistance	$R_{\theta JA}$	47	$^{\circ}\text{C/W}$

<b>ELECTRICAL SPECIFICATIONS</b> ( $T_A = 25^{\circ}\text{C}$ unless otherwise noted)						
<b>PARAMETER</b>		<b>CONDITIONS</b>	<b>SYMBOL</b>	<b>TYP</b>	<b>MAX</b>	<b>UNIT</b>
Forward voltage <sup>(1)</sup>	ES3A ES3B ES3C ES3D	$I_F = 3\text{A}, T_J = 25^{\circ}\text{C}$	$V_F$	-	0.95	V
	ES3F ES3G			-	1.30	V
	ES3H ES3J			-	1.70	V
Reverse current @ rated $V_R$ <sup>(2)</sup>		$T_J = 25^{\circ}\text{C}$	$I_R$	-	10	$\mu\text{A}$
		$T_J = 100^{\circ}\text{C}$		-	500	$\mu\text{A}$
Junction capacitance	ES3A ES3B ES3C ES3D	1MHz, $V_R = 4.0\text{V}$	$C_J$	45	-	pF
	ES3F ES3G ES3H ES3J			30	-	pF
Reverse recovery time		$I_F = 0.5\text{A}, I_R = 1.0\text{A}, I_{rr} = 0.25\text{A}$	$t_{rr}$	-	35	ns

**Notes:**

1. Pulse test with  $PW = 0.3\text{ms}$
2. Pulse test with  $PW = 30\text{ms}$

<b>ORDERING INFORMATION</b>		
<b>ORDERING CODE<sup>(1)</sup></b>	<b>PACKAGE</b>	<b>PACKING</b>
ES3x	DO-214AB (SMC)	3,000 / Tape & Reel

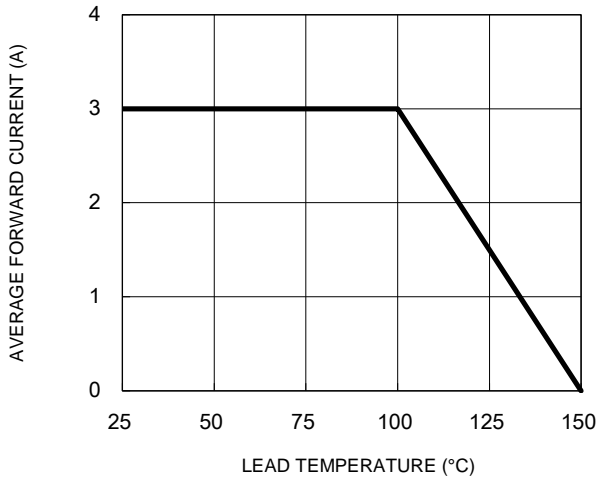
**Notes:**

1. "x" defines voltage from 50V(ES3A) to 600V(ES3J)

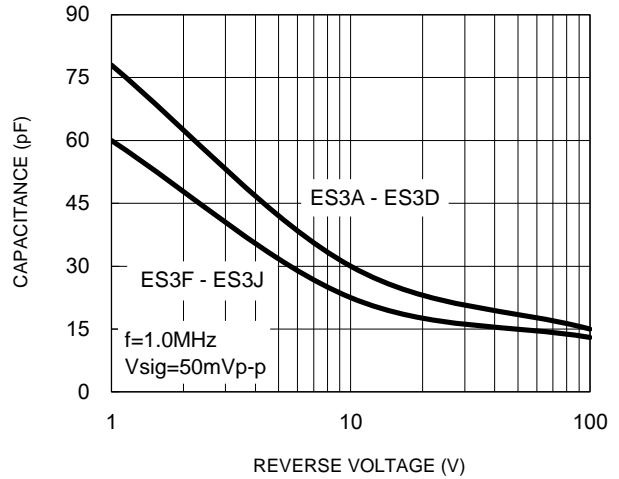
**CHARACTERISTICS CURVES**

( $T_A = 25^\circ\text{C}$  unless otherwise noted)

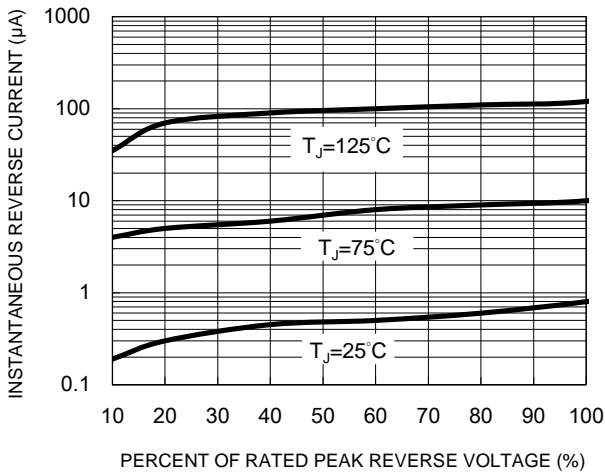
**Fig.1 Forward Current Derating Curve**



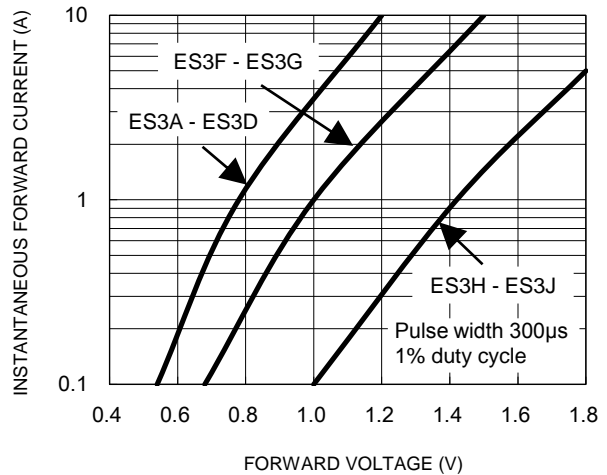
**Fig.2 Typical Junction Capacitance**



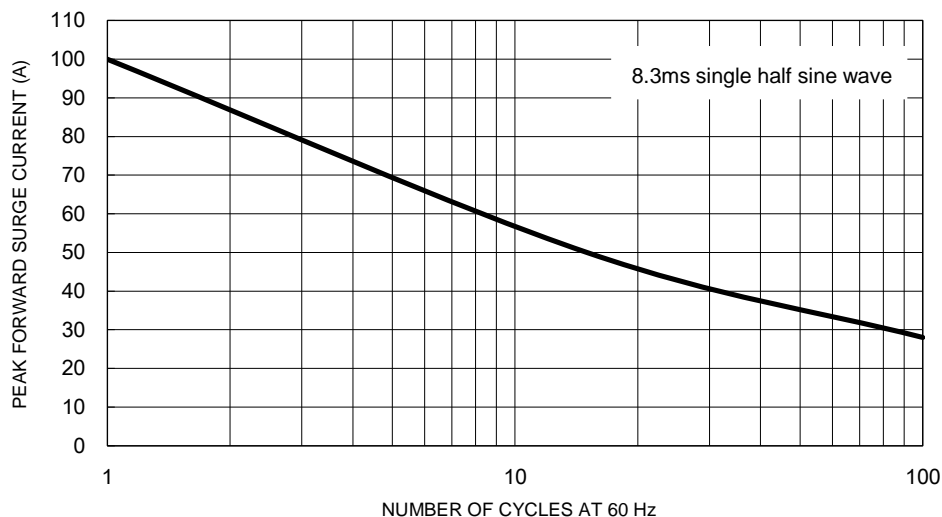
**Fig.3 Typical Reverse Characteristics**



**Fig.4 Typical Forward Characteristics**



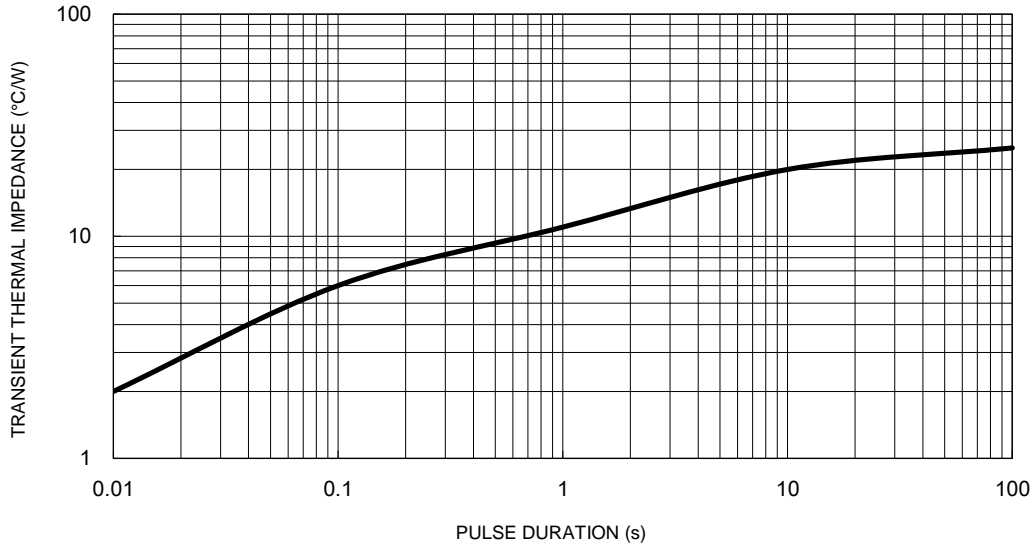
**Fig.5 Maximum Non-Repetitive Forward Surge Current**



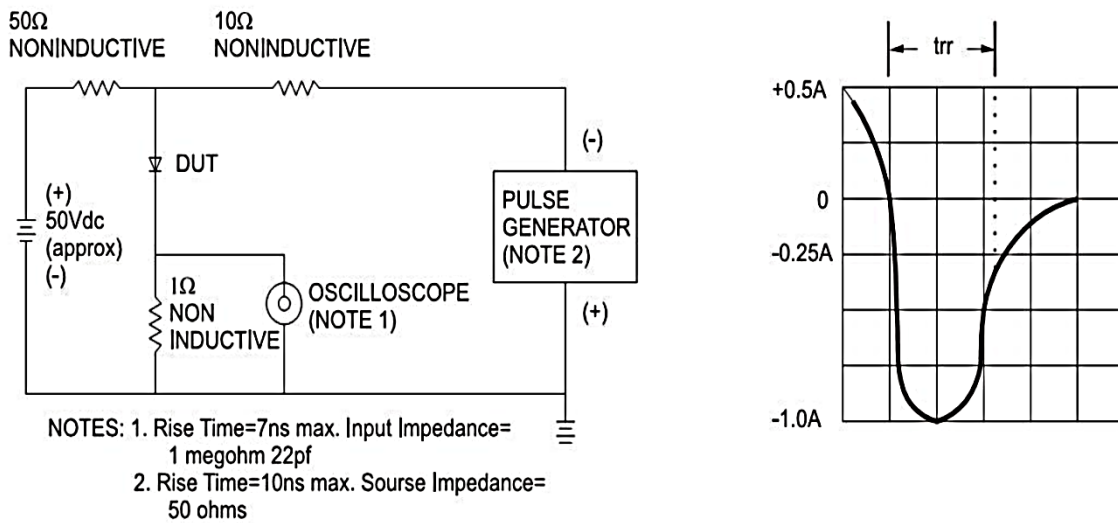
**CHARACTERISTICS CURVES**

( $T_A = 25^\circ\text{C}$  unless otherwise noted)

**Fig.6 Typical Transient Thermal Impedance**

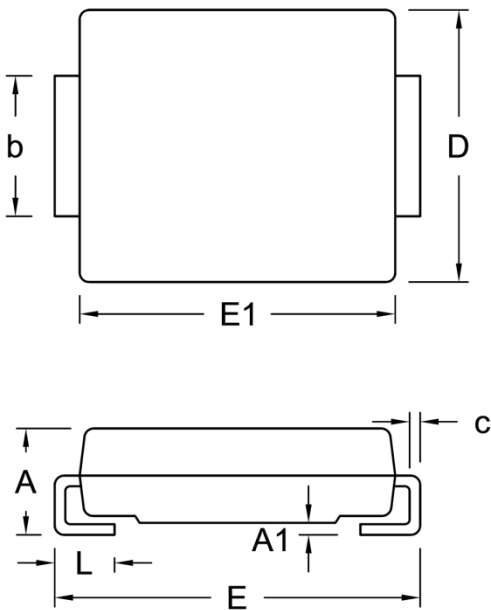


**Fig.7 Reverse Recovery Time Characteristic and Test Circuit Diagram**



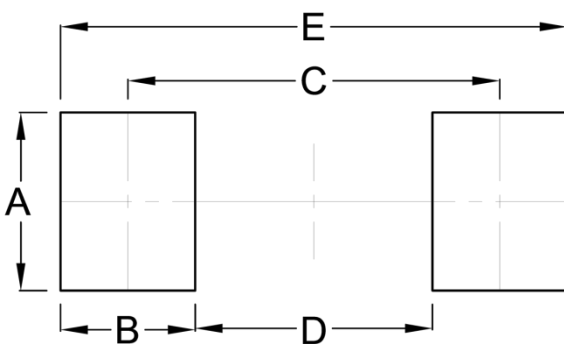
**PACKAGE OUTLINE DIMENSIONS**

DO-214AB (SMC)



DIM.	Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
A	2.00	2.62	0.079	0.103
A1	0.10	0.20	0.004	0.008
b	2.90	3.20	0.114	0.126
c	0.15	0.31	0.006	0.012
D	5.59	6.22	0.220	0.245
E	7.75	8.13	0.305	0.320
E1	6.60	7.11	0.260	0.280
L	1.00	1.60	0.039	0.063

**SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
A	3.30	0.130
B	2.50	0.098
C	6.90	0.272
D	4.40	0.173
E	9.40	0.370

**MARKING DIAGRAM**



- P/N = Marking Code
- G = Green Compound
- YW = Date Code
- F = Factory Code

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